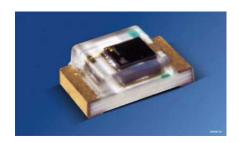
NPN-Si-Fototransistor mit V_{λ} Charakteristik Silicon NPN Phototransistor with V_{λ} Characteristics Lead (Pb) Free Product - RoHS Compliant

SFH 3710



Wesentliche Merkmale

- Sehr kleines SMT Gehäuse
- Angepaßt an die Augenempfindlichkeit (V_{λ})

Anwendungen

- Umgebungslicht-Detektor
- Beleuchtungsmesser
- Dimmungssensor für Hintergrundbeleuchtung
- "Messen/Steuern/Regeln"

Features

- Very small SMT package
- Adapted to human eye sensitivity (V_{λ})

Applications

- Ambient light detector
- · Exposure meter for daylight and artificial light
- Sensor for Backlight-Dimming
- · For control and drive circuits

Тур Туре	Bestellnummer Ordering Code	Fotostrom , $E_{\rm e}$ = 10 µW/cm², λ = 560 nm, $V_{\rm CE}$ = 5 V Photocurrent lpce (µA)
SFH 3710	Q65110A3107	2.512.5
SFH 3710-2/3	Q65110A3512	2.58.0
SFH 3710-3/4	Q65110A3511	4.012.5

Einzelgruppen auf Anfrage / single bins on request



Grenzwerte ($T_{\rm A}$ = 25 $^{\circ}$ C) Maximum Ratings

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit
Betriebs- und Lagertemperatur Operating and storage temperature range	$T_{\rm op};T_{\rm stg}$	- 40 + 85	°C
Kollektor-Emitterspannung Collector-emitter voltage	V_{CE}	5.5	V
Kollektorstrom Collector current	I_{C}	20	mA
Emitter-Kollektorspannung Emitter-collector voltage	V_{EC}	0.5	V

Kennwerte (T_A = 25 $^{\circ}$ C) Characteristics

Bezeichnung Parameter	Symbol Symbol	Wert Value	Einheit Unit	
Wellenlänge der max. Fotoempfindlichkeit Wavelength of max. sensitivity	λ_{Smax}	570	nm	
Spektraler Bereich der Fotoempfindlichkeit $S=10\%$ von $S_{\rm max}$ Spectral range of sensitivity $S=10\%$ of $S_{\rm max}$	λ	350 950	nm	
Bestrahlungsempfindliche Fläche Radiant sensitive area	A	0.29	mm ²	
Abmessung der Chipfläche Dimensions of chip area	$L \times B$ $L \times W$	0.75 × 0.75	mm × mm	
Halbwinkel Half angle	φ	±60	Grad. deg.	
Kapazität, V_{CE} = 0 V, f = 1 MHz, E = 0 Capacitance	$C_{\sf CE}$	4	pF	
Dunkelstrom Dark current $V_{\rm R}$ = 5 V	I_{CEO}	3 (< 50)	nA	
Temperturkoeffizient Temperature Coefficient Normlicht A / Standard Light A $\lambda = 550 \text{ nm}$	<i>TK TK</i> _{550 nm}	0.9 0.78	%/K %/K	

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Kennwerte (T_A = 25 $^{\circ}$ C) Characteristics

Bezeichnung Parameter	Symbol Symbol	Wert Value		Einheit Unit	
		-2	-3	-4	
Fotostrom Photocurrent $E_{\rm e}$ = 10 µW/cm², λ = 560 nm, $V_{\rm CE}$ = 5 V $E_{\rm v}$ = 1000 lx, Normlicht/Standard light A	$I_{\sf PCE}$	2.55 220	48 350	6.312.5 570	μΑ μΑ
Kollektor-Emitter-Sättigungsspannung Collector-emitter saturation voltage $I_{\rm C} = I_{\rm PCEmin}^{-1)} \times 0.3, E_{\rm e} = 10 \ \mu \text{W/cm}^2, \ \lambda = 560 \ \text{nm}$	V_{CEsat}	100	100	100	mV

 $^{^{\}mathrm{1})}$ I_{PCEmin} ist der minimale Fotostrom der jeweiligen Gruppe

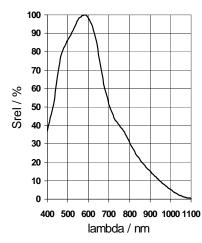




 $^{^{\}rm 1)}~~I_{\rm PCEmin}$ is the min. photocurrent of the specified group

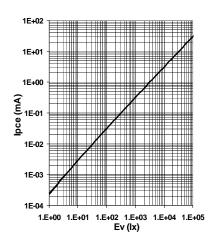
Relative Spectral Sensitivity

 $S_{\text{rel}} = f(\lambda)$



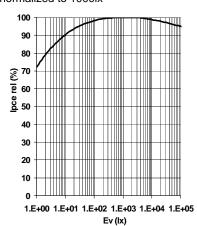
Photocurrent

 $I_{PCE} = f(E_{V}), V_{CE} = 5 \text{ V}$



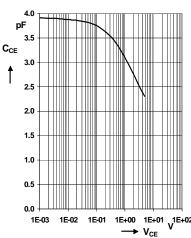
Photocurrent

 $I_{\rm PCE}$ = f ($E_{\rm V}$), $V_{\rm CE}$ = 5 V normalized to 1000lx



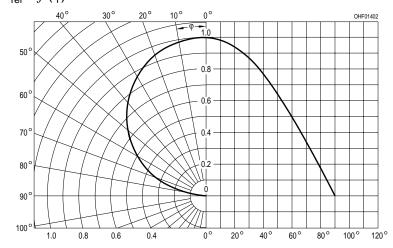
Collector-Emitter Capacitance

 $C_{\mathsf{CE}} = f(V_{\mathsf{CE}})$



Directional Characteristics

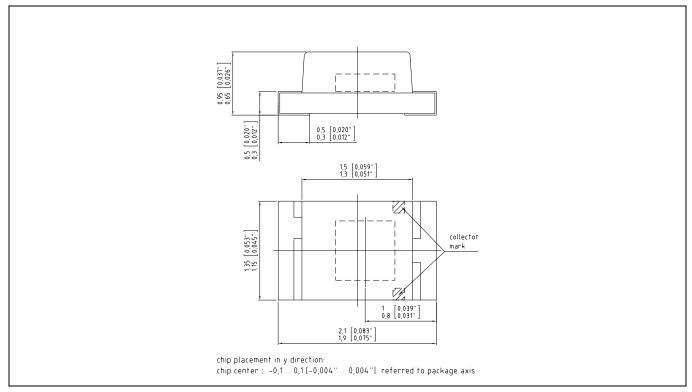
 $S_{\text{rel}} = f(\varphi)$



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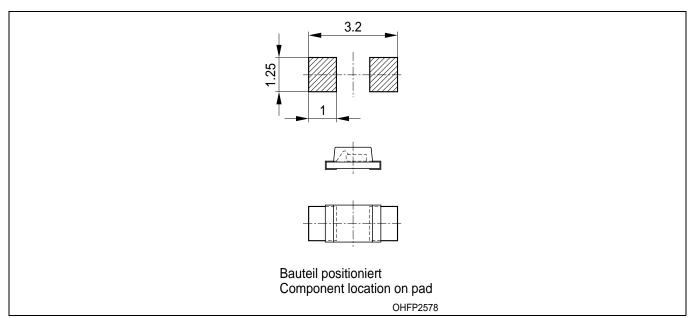
4

Maßzeichnung Package Outlines



Maße in mm (inch) / Dimensions in mm (inch)

Empfohlenes Lötpaddesign Recommended Solderpad Design

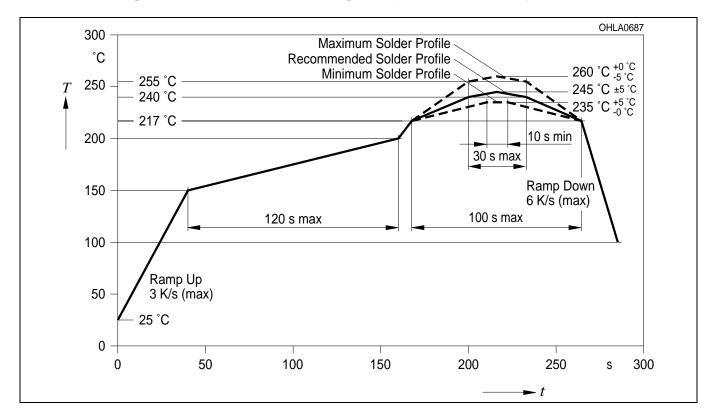


Maße in mm / Dimensions in mm

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Lötbedingungen Soldering Conditions Reflow Lötprofil für bleifreies Löten Reflow Soldering Profile for lead free soldering Vorbehandlung nach JEDEC Level 2 Preconditioning acc. to JEDEC Level 2 (nach J-STD-020C) (acc. to J-STD-020C)



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Packing

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² Life support devices or systems are intended (a) to be implanted in the human body, or (b) to support and/or maintain and sustain human life. If they fail, it is reasonable to assume that the health of the user may be endangered.

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